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Hex Inverter MM74HC04

General Description

The MM74HC04 inverters utilize advanced silicon–gate CMOS technology to achieve operating speeds similar to LS–TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HC04 is a triple buffered inverter. It has high noise immunity and the ability to drive 10 LS–TTL loads. The 74HC logic family is functionally as well as pin–out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical Propagation Delay: 8 ns
- Fan Out of 10 LS-TTL Loads
- Quiescent Power Consumption: 10 µW Maximum at Room Temperature
- Low Input Current: 1 µA Maximum
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

Connection Diagram

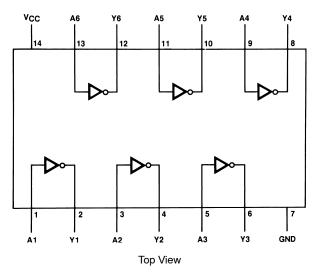


Figure 1. Pin Assignments for SOIC and TSSOP

Logic Diagram

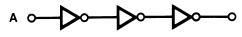


Figure 2. 1 of 6 Inverters

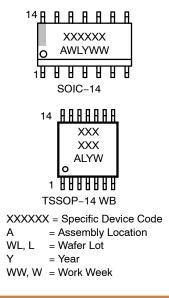


SOIC-14 CASE 751EF



CASE 948G

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	–0.5 to +6.5 V
V _{IN}	DC Input Voltage	–0.5 to V _{CC} + 0.5 V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} + 0.5 V
I _{IK} , I _{OK}	Clamp Diode Current	±20 mA
I _{OUT}	DC Output Current, per Pin	±25 mA
I _{CC}	DC V _{CC} or GND Current, per Pin	±50 mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
PD	Power Dissipation SOIC TSSOP	1077 mW 833 mW
ΤL	Lead Temperature (Soldering 10 Seconds)	260°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter			Max	Unit
V _{CC}	Supply Voltage	Supply Voltage			
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V	
T _A	Operating Temperature Range		-55	+125	°C
t _r , t _f	Input Rise or Fall Times	V _{CC} = 2.0 V	-	1000	ns
		V _{CC} = 4.5 V	-	500	ns
		$V_{CC} = 6.0 V$	-	400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

MM74HC04

DC CHARACTERISTICS (Note 2)

		Vcc		T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	(V)	Conditions	Тур		Guaranteed L	imits	Unit
V _{IH}	Minimum HIGH Level Input Voltage	2.0		-	1.5	1.5	1.5	V
		4.5		-	3.15	3.15	3.15	
		6.0		-	4.2	4.2	4.2	
V _{IL}	Maximum LOW Level Input Voltage	2.0		-	0.5	0.5	0.5	V
		4.5		-	1.35	1.35	1.35	
		6.0		-	1.8	1.8	1.8	
V _{OH}	Minimum HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.9	1.9	1.9	V
		4.5	I _{OUT} ≤ 20 μA	4.5	4.4	4.4	4.4	
		6.0		6.0	5.9	5.9	5.9	
		4.5	$\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL}, \\ \left I_{OUT} \right \leq 4.0 \text{ mA} \end{array}$	4.2	3.98	3.84	3.7	
		6.0	$\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL}, \\ \left I_{OUT} \right \leq 5.2 \text{ mA} \end{array}$	5.7	5.48	5.34	5.2	
V _{OL}	Maximum LOW Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IH},$	0	0.1	0.1	0.1	V
		4.5	I _{OUT} ≤ 20 μΑ	0	0.1	0.1	0.1	
		6.0		0	0.1	0.1	0.1	
		4.5	$\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IH}, \\ \left I_{OUT}\right \leq 4.0 \text{ mA} \end{array}$	0.2	0.26	0.33	0.4	
		6.0	V_{IN} = V_{IH} or V_{IH} , $ I_{OUT} \le 5.2 \text{ mA}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND	-	±0.1	±1.0	±1.0	μA
Icc	Maximum Quiescent Supply Current	6.0	$V_{IN} = V_{CC} \text{ or}$ GND, $I_{OUT} = 0 \ \mu A$	-	2.0	20	40	μA

2. For a power supply of 5 V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

AC CHARACTERISTICS (V_{CC} = 5 V, T_A = 25°C, C_L = 15 pF, $t_r = t_f = 6$ ns)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay		8	15	ns

AC CHARACTERISTICS (V_{CC} = 2.0 V to 6.0 V, C_L = 50 pF, t_r = t_f = 6 ns (unless otherwise specified))

		Vcc		T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	(V)	Conditions	Тур		Guaranteed L	imits	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay	2.0		55	95	120	145	ns
		4.5		11	19	24	29	
		6.0		9	16	20	24	
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time	2.0		30	75	95	110	ns
		4.5		8	15	19	22	
		6.0		7	13	16	19	
C _{PD}	Power Dissipation Capacitance (Note 3)		(per gate)	20	-	-	-	pF
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM74HC04

ORDERING INFORMATION

Part Number	Marking	Package	Shipping [†]
MM74HC04M	HC04A	SOIC-14, Case 751A (Pb-Free, Halide-Free)	55 Units / Tube
MM74HC04MX	HC04A	SOIC-14, Case 751EF (Pb-Free, Halide-Free)	2500 Units / Tape & Reel
MM74HC04MTCX	HC 04A	TSSOP-14, Case 948G (Pb-Free, Halide Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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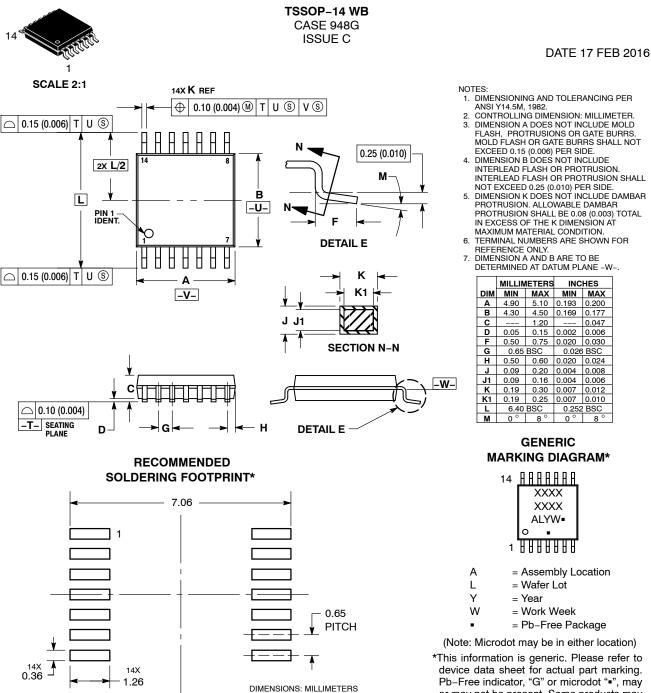
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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 Α 8.50 0.65 7.62 14 8 14 8 В ₽ ╞ 4.00 6.00 5.60 3.80 Ħ = ╞ = Ħ 1.70 7 **PIN #1** 7 1.27 1 0.51 IDENT. 1.270.35 (0.33) - \oplus 0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 0.19 0.10 С 1.50 0.25 1.25 0.10 SIDE VIEW FRONT VIEW NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS R0.10 GAGE D. LAND PATTERN STANDARD: PLANE SOIC127P600X145-14M E. CONFORMS TO ASME Y14.5M, 2009 R0.10 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)**DETAIL A** SCALE 16:1

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*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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